

Welcome to [E-XFL.COM](#)

#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

#### Details

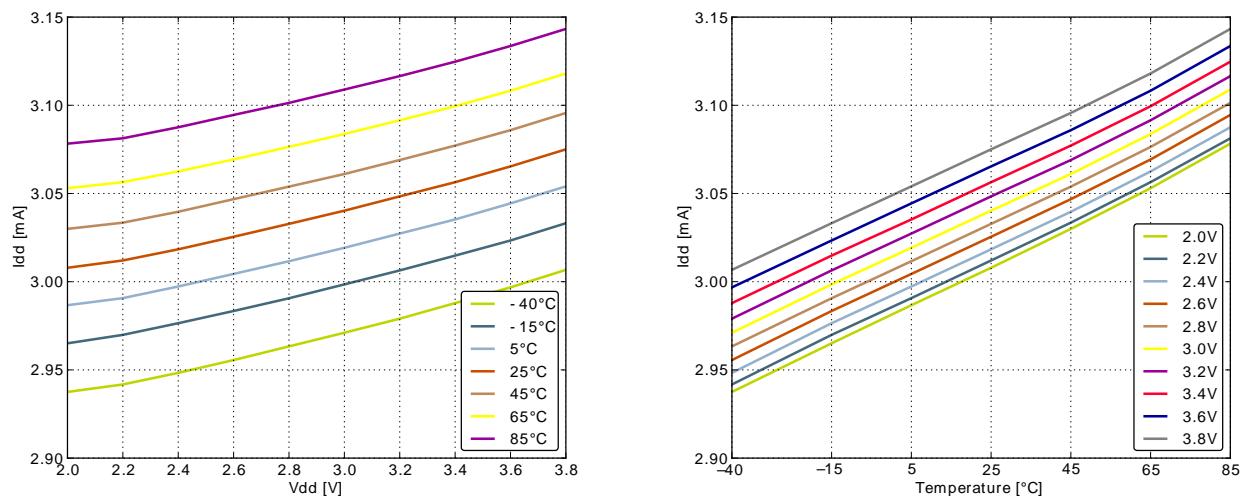
|                            |   |
|----------------------------|---|
| Product Status             | Discontinued at Digi-Key  |
| Core Processor             | ARM® Cortex®-M4F  |
| Core Size                  | 32-Bit Single-Core  |
| Speed                      | 48MHz   |
| Connectivity               | EBI/EMI, I²C, IrDA, SmartCard, SPI, UART/USART  |
| Peripherals                | Brown-out Detect/Reset, DMA, I²S, LCD, POR, PWM, WDT  |
| Number of I/O              | 93  |
| Program Memory Size        | 128KB (128K x 8)  |
| Program Memory Type        | FLASH   |
| EEPROM Size                | -   |
| RAM Size                   | 32K x 8   |
| Voltage - Supply (Vcc/Vdd) | 1.98V ~ 3.8V  |
| Data Converters            | A/D 8x12b; D/A 2x12b  |
| Oscillator Type            | Internal  |
| Operating Temperature      | -40°C ~ 85°C (TA)   |
| Mounting Type              | Surface Mount   |
| Package / Case             | 120-VFBGA   |
| Supplier Device Package    | -   |
| Purchase URL               | <a href="https://www.e-xfl.com/product-detail/silicon-labs/efm32wg895f128-bga120t">https://www.e-xfl.com/product-detail/silicon-labs/efm32wg895f128-bga120t</a> |

| Symbol    | Parameter   | Condition  | Min | Typ              | Max              | Unit          |
|-----------|-------------|--|-----|------------------|------------------|---------------|
|           |             | EM2 current with RTC prescaled to 1 Hz, 32.768 kHz LFRCO, $V_{DD} = 3.0$ V, $T_{AMB} = 85^\circ\text{C}$ |     | 3.0 <sup>1</sup> | 4.0 <sup>1</sup> | $\mu\text{A}$ |
| $I_{EM3}$ | EM3 current | $V_{DD} = 3.0$ V, $T_{AMB} = 25^\circ\text{C}$   |     | 0.65             | 1.3              | $\mu\text{A}$ |
|           |             | $V_{DD} = 3.0$ V, $T_{AMB} = 85^\circ\text{C}$   |     | 2.65             | 4.0              | $\mu\text{A}$ |
| $I_{EM4}$ | EM4 current | $V_{DD} = 3.0$ V, $T_{AMB} = 25^\circ\text{C}$   |     | 0.02             | 0.055            | $\mu\text{A}$ |
|           |             | $V_{DD} = 3.0$ V, $T_{AMB} = 85^\circ\text{C}$   |     | 0.44             | 0.9              | $\mu\text{A}$ |

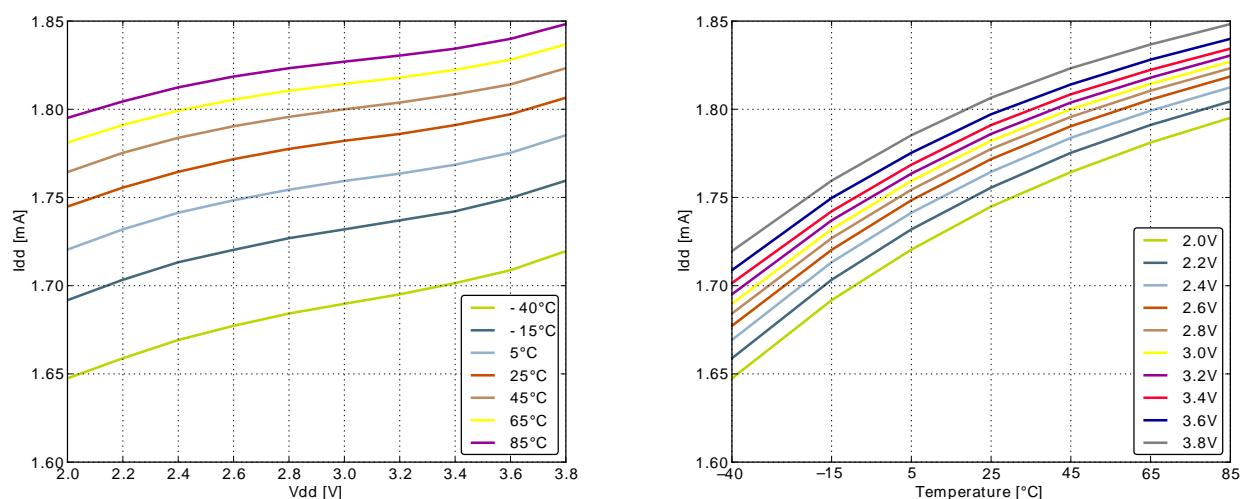
<sup>1</sup>Using backup RTC.

### 3.4.1 EM1 Current Consumption

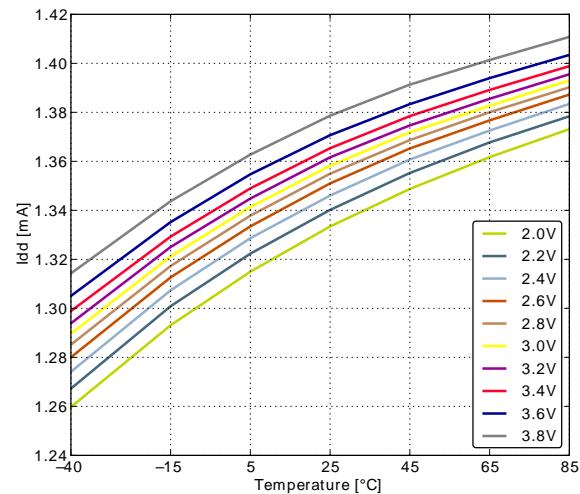
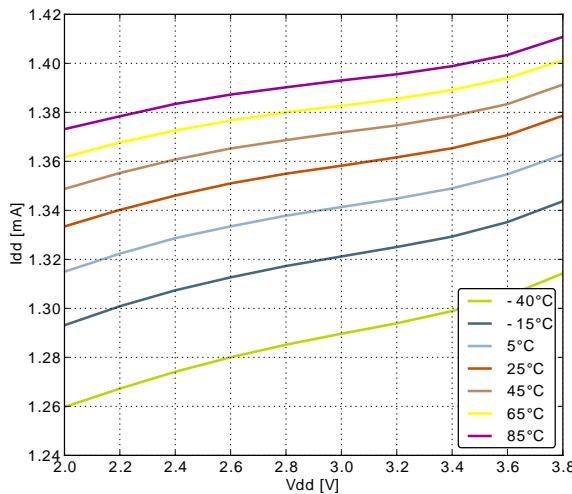
**Figure 3.1. EM1 Current consumption with all peripheral clocks disabled and HFXO running at 48MHz**



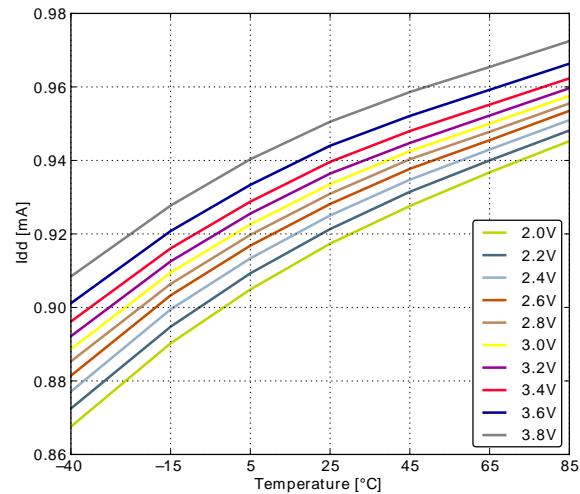
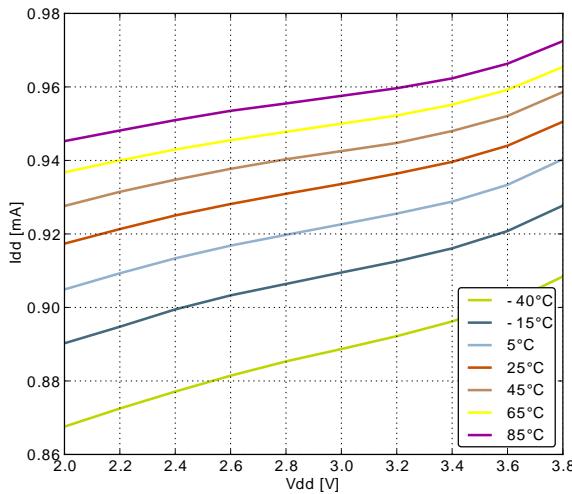
**Figure 3.2. EM1 Current consumption with all peripheral clocks disabled and HFRCO running at 28MHz**



**Figure 3.3. EM1 Current consumption with all peripheral clocks disabled and HFRCO running at 21MHz**

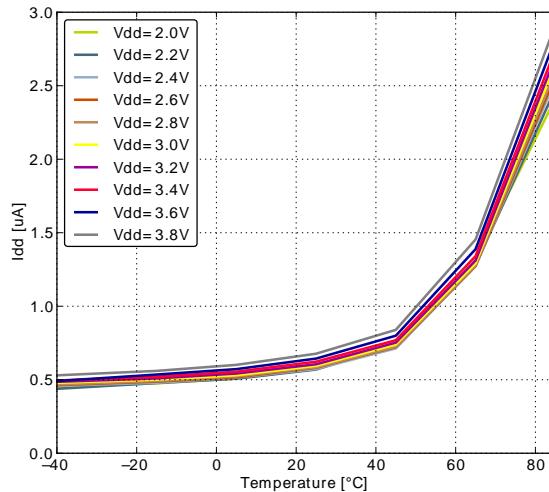
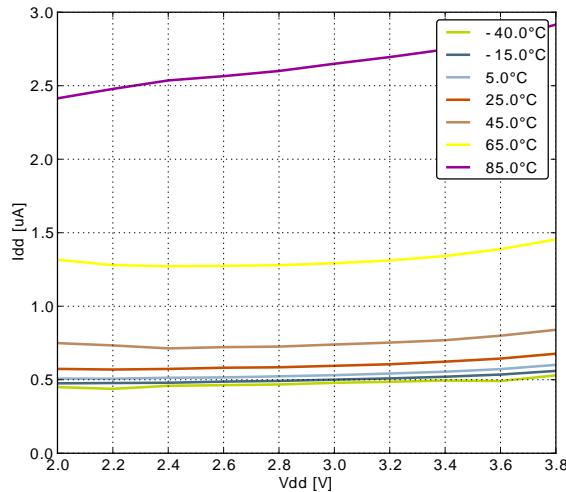


**Figure 3.4. EM1 Current consumption with all peripheral clocks disabled and HFRCO running at 14MHz**



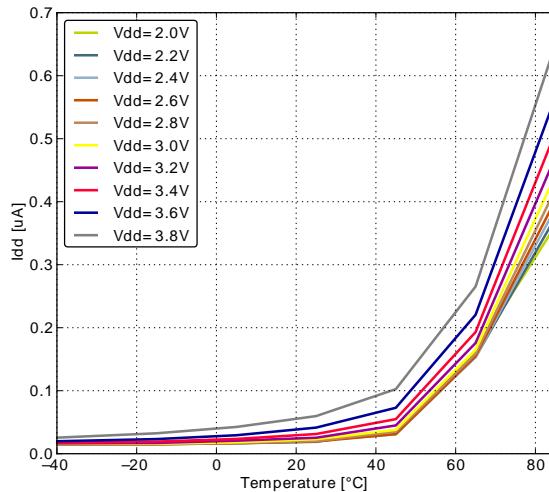
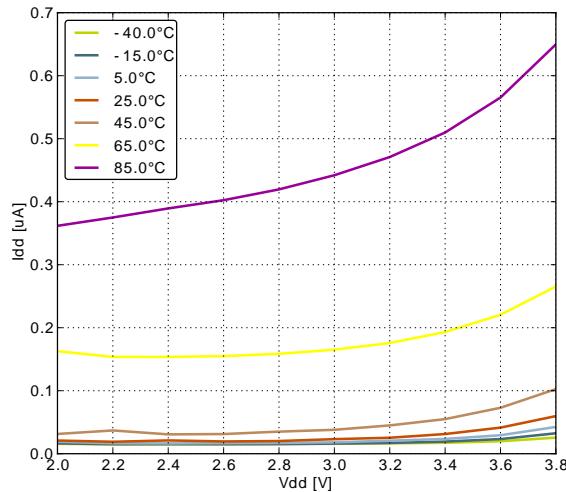
### 3.4.3 EM3 Current Consumption

**Figure 3.9.** *EM3 current consumption.*



### 3.4.4 EM4 Current Consumption

**Figure 3.10.** *EM4 current consumption.*



## 3.5 Transition between Energy Modes

The transition times are measured from the trigger to the first clock edge in the CPU.

**Table 3.5. Energy Modes Transitions**

| Symbol     | Parameter                       | Min | Typ | Max | Unit               |
|------------|---------------------------------|-----|-----|-----|--------------------|
| $t_{EM10}$ | Transition time from EM1 to EM0 |     | 0   |     | HF-CORE-CLK cycles |
| $t_{EM20}$ | Transition time from EM2 to EM0 |     | 2   |     | μs                 |
| $t_{EM30}$ | Transition time from EM3 to EM0 |     | 2   |     | μs                 |
| $t_{EM40}$ | Transition time from EM4 to EM0 |     | 163 |     | μs                 |

## 3.6 Power Management

The EFM32WG requires the AVDD\_x, VDD\_DREG and IOVDD\_x pins to be connected together (with optional filter) at the PCB level. For practical schematic recommendations, please see the application note, "AN0002 EFM32 Hardware Design Considerations".

**Table 3.6. Power Management**

| Symbol                  | Parameter  | Condition  | Min  | Typ  | Max  | Unit |
|-------------------------|--|--|------|------|------|------|
| V <sub>BODextthr-</sub> | BOD threshold on falling external supply voltage                 |  | 1.74 |      | 1.96 | V    |
| V <sub>BODextthr+</sub> | BOD threshold on rising external supply voltage                  |  |      | 1.85 | 1.98 | V    |
| V <sub>PORthr+</sub>    | Power-on Reset (POR) threshold on rising external supply voltage |  |      |      | 1.98 | V    |
| t <sub>RESET</sub>      | Delay from reset is released until program execution starts      | Applies to Power-on Reset, Brown-out Reset and pin reset.        |      | 163  |      | μs   |
| C <sub>DECOPPLE</sub>   | Voltage regulator decoupling capacitor.                          | X5R capacitor recommended. Apply between DECOUPLE pin and GROUND |      | 1    |      | μF   |

## 3.7 Flash

**Table 3.7. Flash**

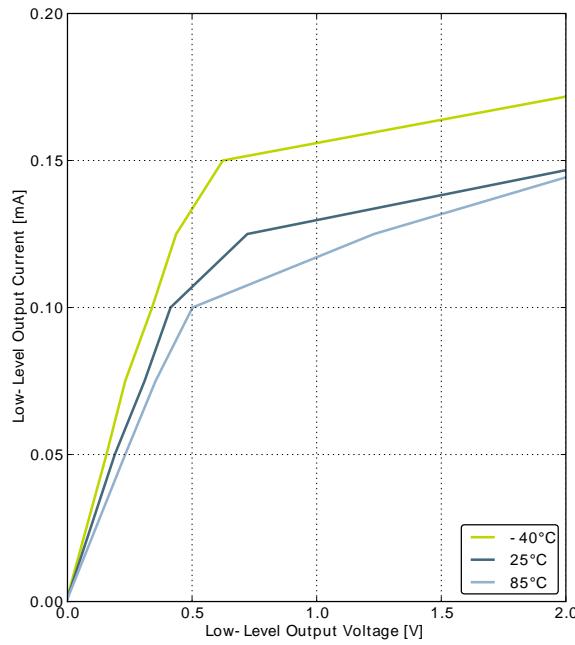
| Symbol               | Parameter                                   | Condition               | Min   | Typ  | Max            | Unit   |
|----------------------|---|-------------------------|-------|------|----------------|--------|
| EC <sub>FLASH</sub>  | Flash erase cycles before failure           |                         | 20000 |      |                | cycles |
| RET <sub>FLASH</sub> | Flash data retention                        | T <sub>AMB</sub> <150°C | 10000 |      |                | h      |
|                      |   | T <sub>AMB</sub> <85°C  | 10    |      |                | years  |
|                      |   | T <sub>AMB</sub> <70°C  | 20    |      |                | years  |
| t <sub>W_PROG</sub>  | Word (32-bit) programming time              |                         | 20    |      |                | μs     |
| t <sub>PERASE</sub>  | Page erase time                             |                         | 20    | 20.4 | 20.8           | ms     |
| t <sub>DERASE</sub>  | Device erase time                           |                         | 40    | 40.8 | 41.6           | ms     |
| I <sub>ERASE</sub>   | Erase current                               |                         |       |      | 7 <sup>1</sup> | mA     |
| I <sub>WRITE</sub>   | Write current                               |                         |       |      | 7 <sup>1</sup> | mA     |
| V <sub>FLASH</sub>   | Supply voltage during flash erase and write |                         | 1.98  |      | 3.8            | V      |

<sup>1</sup>Measured at 25°C

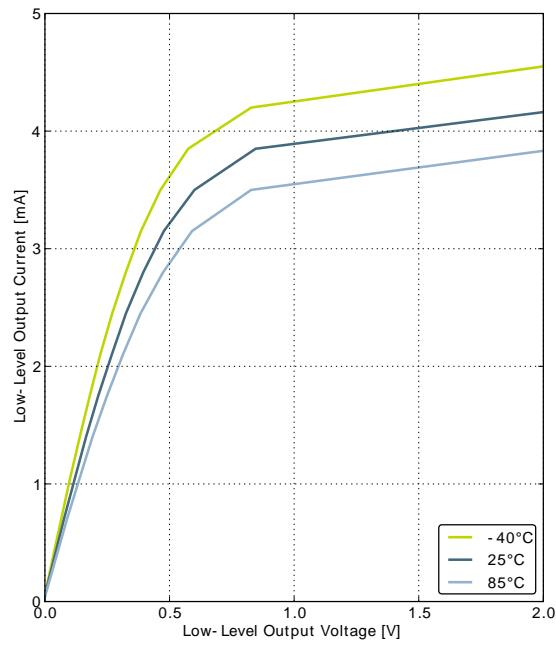
## 3.8 General Purpose Input Output

**Table 3.8. GPIO**

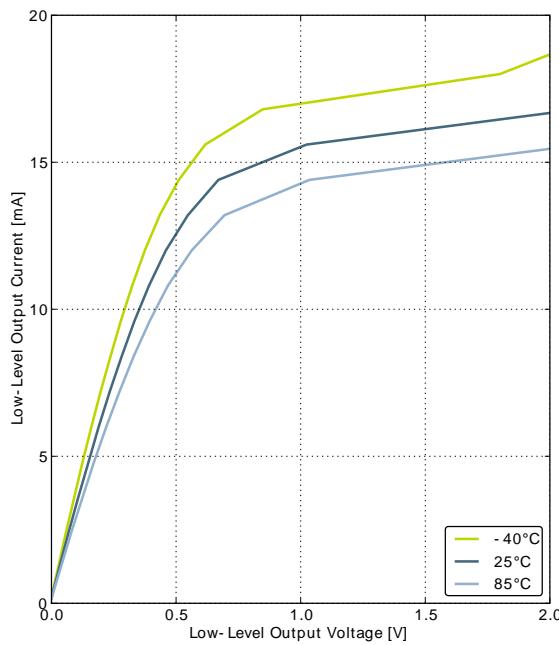
| Symbol     | Parameter  | Condition   | Min          | Typ          | Max          | Unit |
|------------|--|---|--------------|--------------|--------------|------|
| $V_{IOIL}$ | Input low voltage  |   |              |              | $0.30V_{DD}$ | V    |
| $V_{IOIH}$ | Input high voltage   |   | $0.70V_{DD}$ |              |              | V    |
| $V_{IOOH}$ | Output high voltage (Production test condition = 3.0V, DRIVEMODE = STANDARD) | Sourcing 0.1 mA, $V_{DD}=1.98$ V, GPIO_Px_CTRL DRIVEMODE = LOWEST |              | $0.80V_{DD}$ |              | V    |
|            |  | Sourcing 0.1 mA, $V_{DD}=3.0$ V, GPIO_Px_CTRL DRIVEMODE = LOWEST  |              | $0.90V_{DD}$ |              | V    |
|            |  | Sourcing 1 mA, $V_{DD}=1.98$ V, GPIO_Px_CTRL DRIVEMODE = LOW      |              | $0.85V_{DD}$ |              | V    |
|            |  | Sourcing 1 mA, $V_{DD}=3.0$ V, GPIO_Px_CTRL DRIVEMODE = LOW       |              | $0.90V_{DD}$ |              | V    |
|            |  | Sourcing 6 mA, $V_{DD}=1.98$ V, GPIO_Px_CTRL DRIVEMODE = STANDARD | $0.75V_{DD}$ |              |              | V    |
|            |  | Sourcing 6 mA, $V_{DD}=3.0$ V, GPIO_Px_CTRL DRIVEMODE = STANDARD  | $0.85V_{DD}$ |              |              | V    |
|            |  | Sourcing 20 mA, $V_{DD}=1.98$ V, GPIO_Px_CTRL DRIVEMODE = HIGH    | $0.60V_{DD}$ |              |              | V    |
|            |  | Sourcing 20 mA, $V_{DD}=3.0$ V, GPIO_Px_CTRL DRIVEMODE = HIGH     | $0.80V_{DD}$ |              |              | V    |
| $V_{IOOL}$ | Output low voltage (Production test condition = 3.0V, DRIVEMODE = STANDARD)  | Sinking 0.1 mA, $V_{DD}=1.98$ V, GPIO_Px_CTRL DRIVEMODE = LOWEST  |              | $0.20V_{DD}$ |              | V    |
|            |  | Sinking 0.1 mA, $V_{DD}=3.0$ V, GPIO_Px_CTRL DRIVEMODE = LOWEST   |              | $0.10V_{DD}$ |              | V    |
|            |  | Sinking 1 mA, $V_{DD}=1.98$ V, GPIO_Px_CTRL DRIVEMODE = LOW       |              | $0.10V_{DD}$ |              | V    |
|            |  | Sinking 1 mA, $V_{DD}=3.0$ V, GPIO_Px_CTRL DRIVEMODE = LOW        |              | $0.05V_{DD}$ |              | V    |
|            |  | Sinking 6 mA, $V_{DD}=1.98$ V, GPIO_Px_CTRL DRIVEMODE = STANDARD  |              |              | $0.30V_{DD}$ | V    |
|            |  | Sinking 6 mA, $V_{DD}=3.0$ V, GPIO_Px_CTRL DRIVEMODE = STANDARD   |              |              | $0.20V_{DD}$ | V    |
|            |  | Sinking 20 mA, $V_{DD}=1.98$ V, GPIO_Px_CTRL DRIVEMODE = HIGH     |              |              | $0.35V_{DD}$ | V    |

**Figure 3.11. Typical Low-Level Output Current, 2V Supply Voltage**

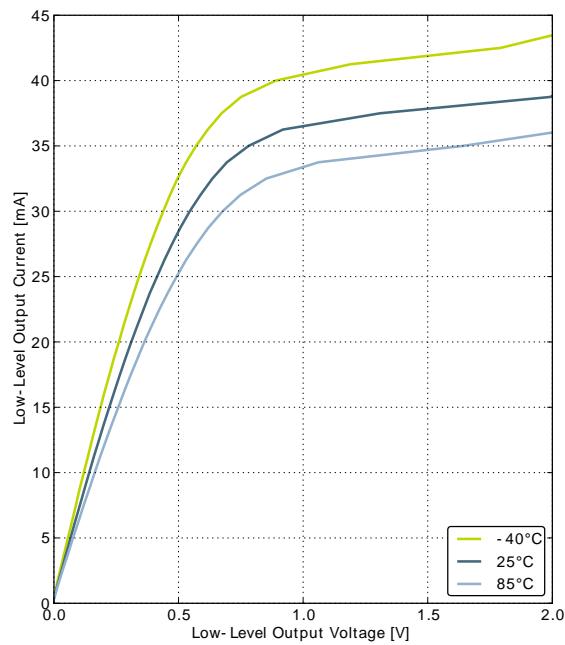
GPIO\_Px\_CTRL DRIVEMODE = LOWEST



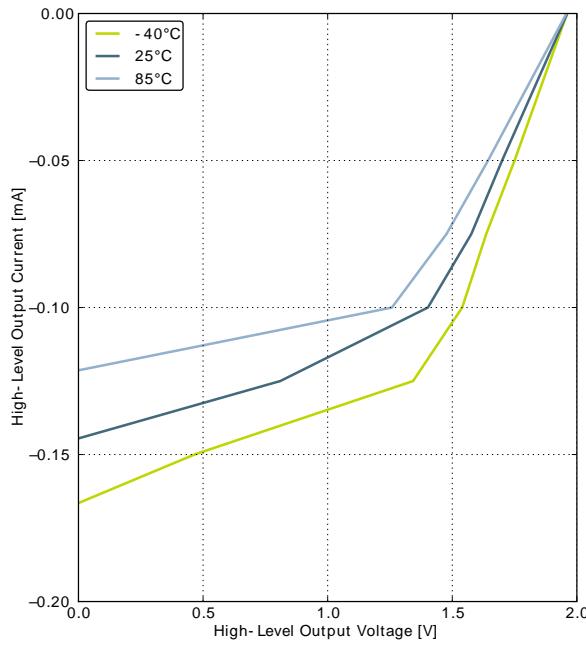
GPIO\_Px\_CTRL DRIVEMODE = LOW



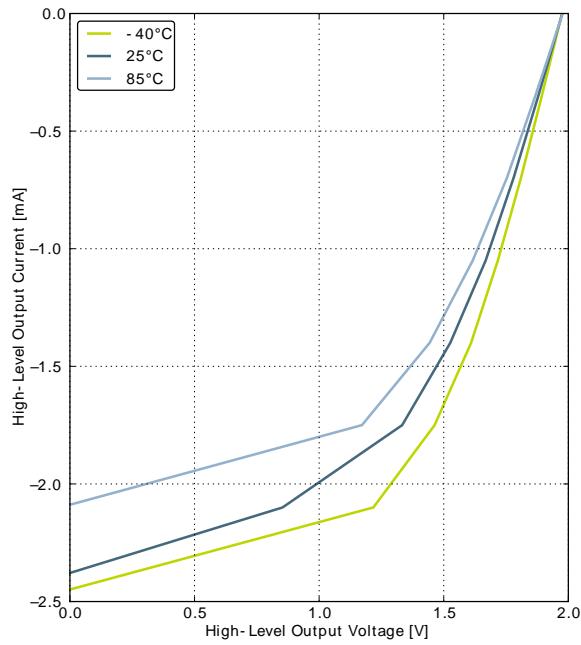
GPIO\_Px\_CTRL DRIVEMODE = STANDARD



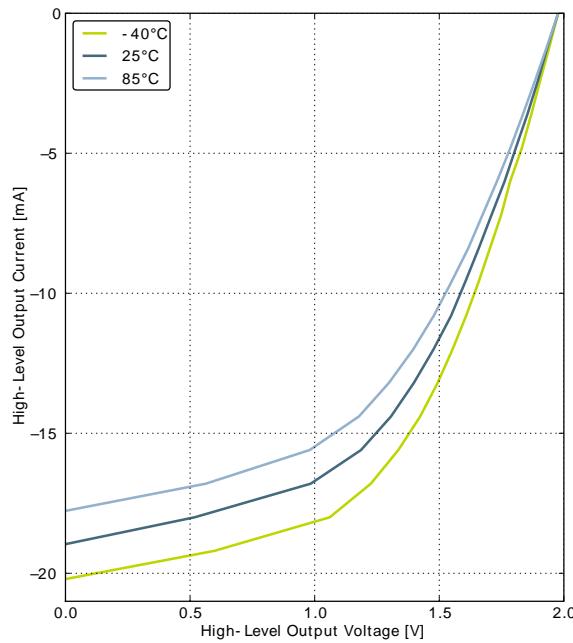
GPIO\_Px\_CTRL DRIVEMODE = HIGH

**Figure 3.12. Typical High-Level Output Current, 2V Supply Voltage**

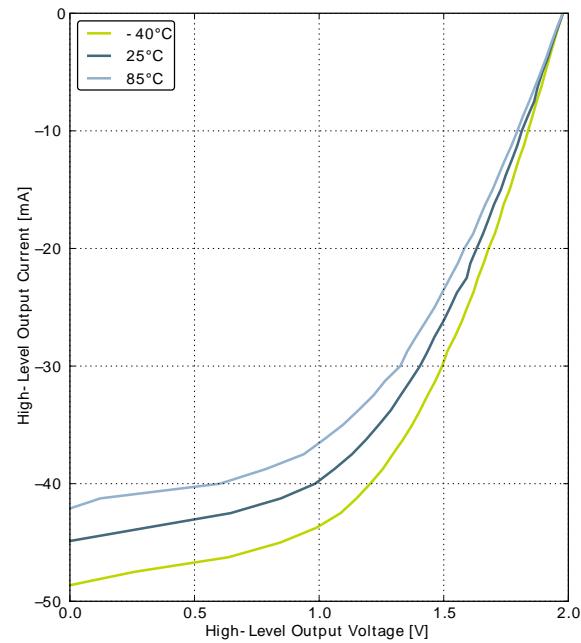
GPIO\_Px\_CTRL DRIVEMODE = LOWEST



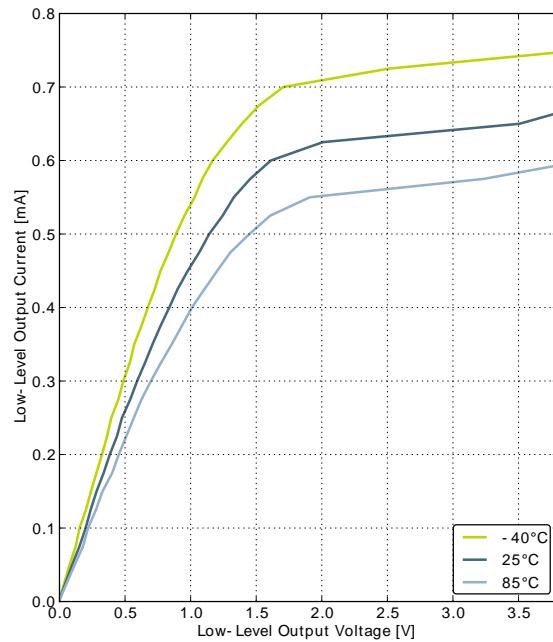
GPIO\_Px\_CTRL DRIVEMODE = LOW



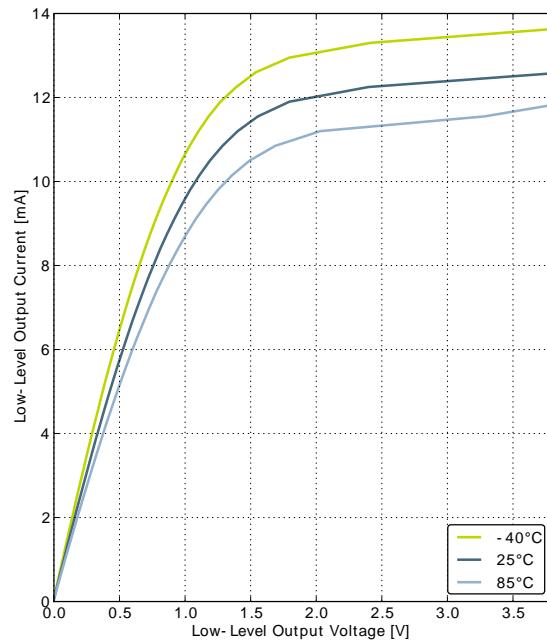
GPIO\_Px\_CTRL DRIVEMODE = STANDARD



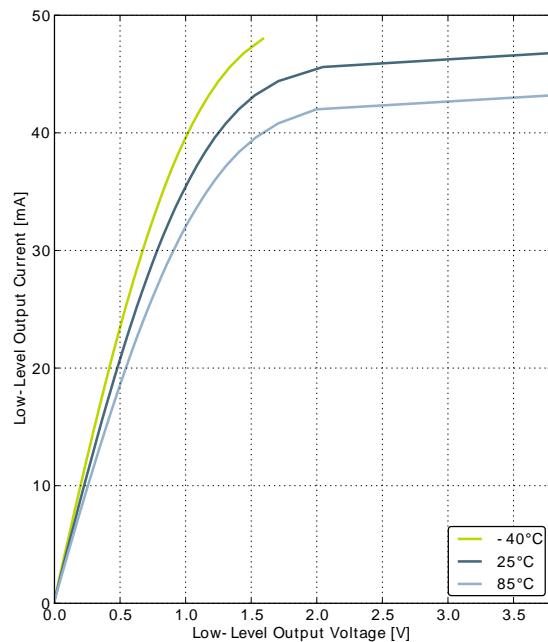
GPIO\_Px\_CTRL DRIVEMODE = HIGH

**Figure 3.15. Typical Low-Level Output Current, 3.8V Supply Voltage**

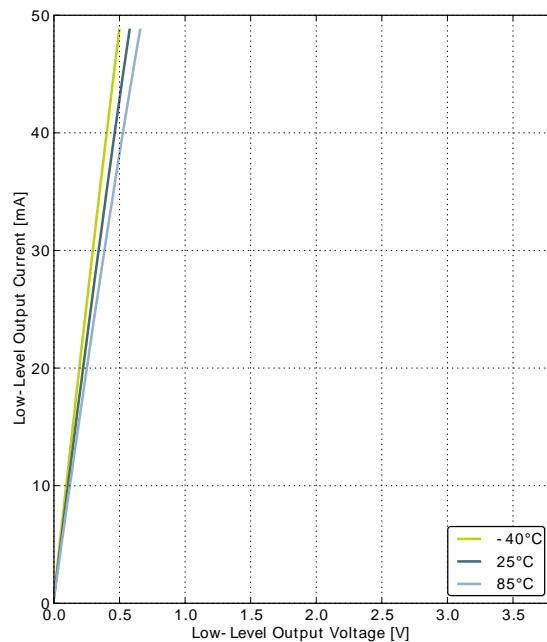
GPIO\_Px\_CTRL DRIVEMODE = LOWEST



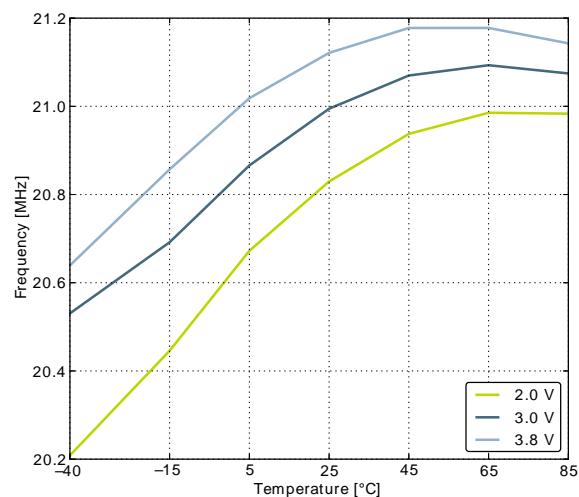
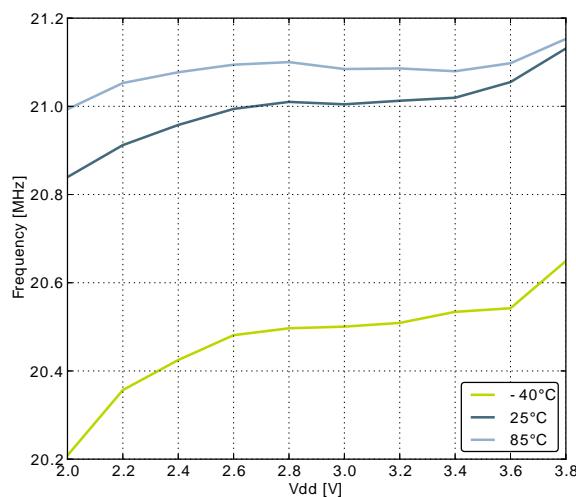
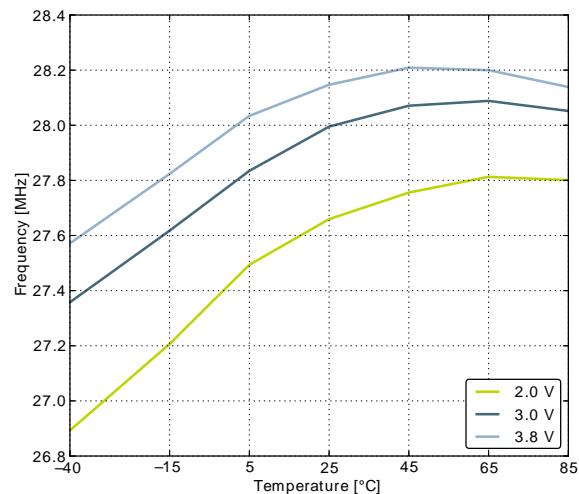
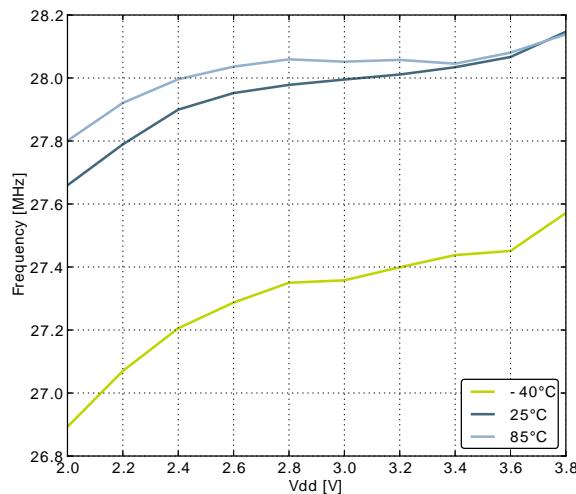
GPIO\_Px\_CTRL DRIVEMODE = LOW



GPIO\_Px\_CTRL DRIVEMODE = STANDARD



GPIO\_Px\_CTRL DRIVEMODE = HIGH

**Figure 3.22. Calibrated HFRCO 21 MHz Band Frequency vs Supply Voltage and Temperature****Figure 3.23. Calibrated HFRCO 28 MHz Band Frequency vs Supply Voltage and Temperature**

| Symbol               | Parameter  | Condition   | Min | Typ | Max | Unit |
|----------------------|--|---|-----|-----|-----|------|
|                      | and ADC core in NORMAL mode  |   |     |     |     |      |
|                      | Startup time of reference generator and ADC core in KEEPADCWARM mode |   |     | 1   |     | μs   |
| SNR <sub>ADC</sub>   | Signal to Noise Ratio (SNR)  | 1 MSamples/s, 12 bit, single ended, internal 1.25V reference      |     | 59  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, single ended, internal 2.5V reference       |     | 63  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, single ended, V <sub>DD</sub> reference     |     | 65  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, differential, internal 1.25V reference      |     | 60  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, differential, internal 2.5V reference       |     | 65  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, differential, 5V reference                  |     | 54  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, differential, V <sub>DD</sub> reference     |     | 67  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, differential, 2xV <sub>DD</sub> reference   |     | 69  |     | dB   |
|                      |  | 200 kSamples/s, 12 bit, single ended, internal 1.25V reference    |     | 62  |     | dB   |
|                      |  | 200 kSamples/s, 12 bit, single ended, internal 2.5V reference     |     | 63  |     | dB   |
|                      |  | 200 kSamples/s, 12 bit, single ended, V <sub>DD</sub> reference   |     | 67  |     | dB   |
|                      |  | 200 kSamples/s, 12 bit, differential, internal 1.25V reference    |     | 63  |     | dB   |
|                      |  | 200 kSamples/s, 12 bit, differential, internal 2.5V reference     |     | 66  |     | dB   |
|                      |  | 200 kSamples/s, 12 bit, differential, 5V reference                |     | 66  |     | dB   |
|                      |  | 200 kSamples/s, 12 bit, differential, V <sub>DD</sub> reference   | 63  | 66  |     | dB   |
|                      |  | 200 kSamples/s, 12 bit, differential, 2xV <sub>DD</sub> reference |     | 70  |     | dB   |
| SINAD <sub>ADC</sub> | Signal-to-Noise And Distortion-ratio (SINAD)                         | 1 MSamples/s, 12 bit, single ended, internal 1.25V reference      |     | 58  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, single ended, internal 2.5V reference       |     | 62  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, single ended, V <sub>DD</sub> reference     |     | 64  |     | dB   |
|                      |  | 1 MSamples/s, 12 bit, differential, internal 1.25V reference      |     | 60  |     | dB   |

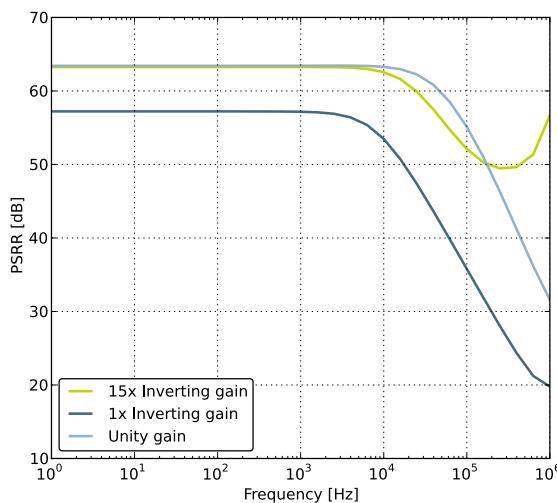
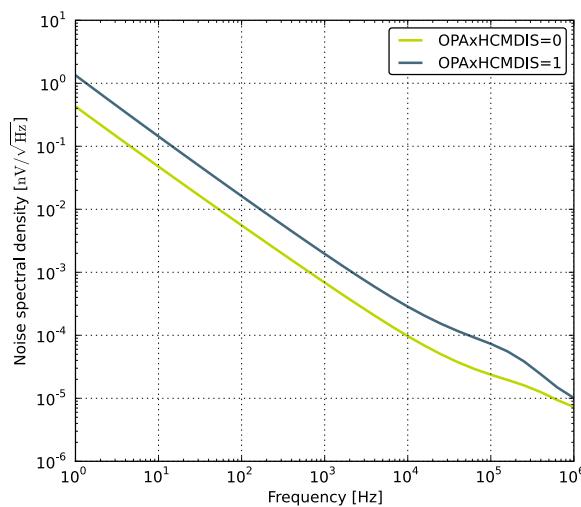
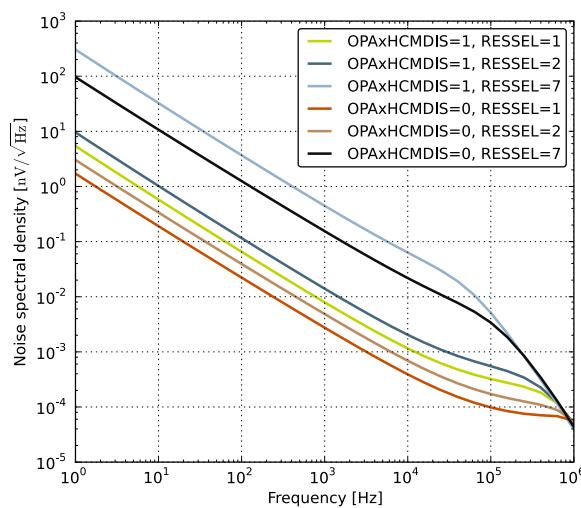
| Symbol                 | Parameter                                      | Condition   | Min                 | Typ               | Max                | Unit         |
|------------------------|--|---|---------------------|-------------------|--------------------|--------------|
|                        |  | 200 kSamples/s, 12 bit, differential, internal 1.25V reference    |                     | 79                |                    | dBc          |
|                        |  | 200 kSamples/s, 12 bit, differential, internal 2.5V reference     |                     | 79                |                    | dBc          |
|                        |  | 200 kSamples/s, 12 bit, differential, 5V reference                |                     | 78                |                    | dBc          |
|                        |  | 200 kSamples/s, 12 bit, differential, V <sub>DD</sub> reference   | 68                  | 79                |                    | dBc          |
|                        |  | 200 kSamples/s, 12 bit, differential, 2xV <sub>DD</sub> reference |                     | 79                |                    | dBc          |
| V <sub>ADCOFFSET</sub> | Offset voltage                                 | After calibration, single ended                                   | -3.5                | 0.3               | 3                  | mV           |
|                        |  | After calibration, differential                                   |                     | 0.3               |                    | mV           |
| TGRAD <sub>ADCTH</sub> | Thermometer output gradient                    |   |                     | -1.92             |                    | mV/°C        |
|                        |  |   |                     | -6.3              |                    | ADC Codes/°C |
| DNL <sub>ADC</sub>     | Differential non-linearity (DNL)               |   | -1                  | ±0.7              | 4                  | LSB          |
| INL <sub>ADC</sub>     | Integral non-linearity (INL), End point method |   |                     | ±1.2              | ±3                 | LSB          |
| MC <sub>ADC</sub>      | No missing codes                               |   | 11.999 <sup>1</sup> | 12                |                    | bits         |
| GAIN <sub>ED</sub>     | Gain error drift                               | 1.25V reference   |                     | 0.01 <sup>2</sup> | 0.033 <sup>3</sup> | %/°C         |
|                        |  | 2.5V reference  |                     | 0.01 <sup>2</sup> | 0.03 <sup>3</sup>  | %/°C         |
| OFFSET <sub>ED</sub>   | Offset error drift                             | 1.25V reference   |                     | 0.2 <sup>2</sup>  | 0.7 <sup>3</sup>   | LSB/°C       |
|                        |  | 2.5V reference  |                     | 0.2 <sup>2</sup>  | 0.62 <sup>3</sup>  | LSB/°C       |

<sup>1</sup>On the average every ADC will have one missing code, most likely to appear around 2048 +/- n\*512 where n can be a value in the set {-3, -2, -1, 1, 2, 3}. There will be no missing code around 2048, and in spite of the missing code the ADC will be monotonic at all times so that a response to a slowly increasing input will always be a slowly increasing output. Around the one code that is missing, the neighbour codes will look wider in the DNL plot. The spectra will show spurs on the level of -78dBc for a full scale input for chips that have the missing code issue.

<sup>2</sup>Typical numbers given by abs(Mean) / (85 - 25).

<sup>3</sup>Max number given by (abs(Mean) + 3x stddev) / (85 - 25).

The integral non-linearity (INL) and differential non-linearity parameters are explained in Figure 3.24 (p. 37) and Figure 3.25 (p. 37) , respectively.

**Figure 3.34. OPAMP Negative Power Supply Rejection Ratio****Figure 3.35. OPAMP Voltage Noise Spectral Density (Unity Gain)  $V_{out}=1V$** **Figure 3.36. OPAMP Voltage Noise Spectral Density (Non-Unity Gain)**

## 3.13 Analog Comparator (ACMP)

**Table 3.18. ACMP**

| Symbol           | Parameter   | Condition   | Min | Typ  | Max      | Unit    |
|------------------|---|---|-----|------|----------|---------|
| $V_{ACMPIN}$     | Input voltage range                               |   | 0   |      | $V_{DD}$ | V       |
| $V_{ACMPCM}$     | ACMP Common Mode voltage range                    |   | 0   |      | $V_{DD}$ | V       |
| $I_{ACMP}$       | Active current                                    | BIASPROG=0b0000, FULL-BIAS=0 and HALFBIAS=1 in ACMPn_CTRL register  |     | 0.1  | 0.4      | $\mu A$ |
|                  |   | BIASPROG=0b1111, FULL-BIAS=0 and HALFBIAS=0 in ACMPn_CTRL register  |     | 2.87 | 15       | $\mu A$ |
|                  |   | BIASPROG=0b1111, FULL-BIAS=1 and HALFBIAS=0 in ACMPn_CTRL register  |     | 195  | 520      | $\mu A$ |
| $I_{ACMPREF}$    | Current consumption of internal voltage reference | Internal voltage reference off. Using external voltage reference    |     | 0    |          | $\mu A$ |
|                  |   | Internal voltage reference  |     | 5    |          | $\mu A$ |
| $V_{ACMPOFFSET}$ | Offset voltage                                    | BIASPROG= 0b1010, FULL-BIAS=0 and HALFBIAS=0 in ACMPn_CTRL register | -12 | 0    | 12       | mV      |
| $V_{ACMPHYST}$   | ACMP hysteresis                                   | Programmable  |     | 17   |          | mV      |
| $R_{CSRES}$      | Capacitive Sense Internal Resistance              | CSRESSEL=0b00 in ACMPn_INPUTSEL                                     |     | 39   |          | kOhm    |
|                  |   | CSRESSEL=0b01 in ACMPn_INPUTSEL                                     |     | 71   |          | kOhm    |
|                  |   | CSRESSEL=0b10 in ACMPn_INPUTSEL                                     |     | 104  |          | kOhm    |
|                  |   | CSRESSEL=0b11 in ACMPn_INPUTSEL                                     |     | 136  |          | kOhm    |
| $t_{ACMPSTART}$  | Startup time                                      |   |     |      | 10       | $\mu s$ |

The total ACMP current is the sum of the contributions from the ACMP and its internal voltage reference as given in Equation 3.1 (p. 47) .  $I_{ACMPREF}$  is zero if an external voltage reference is used.

### Total ACMP Active Current

$$I_{ACMPTOTAL} = I_{ACMP} + I_{ACMPREF} \quad (3.1)$$

## 3.14 Voltage Comparator (VCMP)

**Table 3.19. VCMP**

| Symbol                  | Parameter                        | Condition   | Min | Typ             | Max | Unit |
|-------------------------|----------------------------------|---|-----|-----------------|-----|------|
| V <sub>VCMPIN</sub>     | Input voltage range              |   |     | V <sub>DD</sub> |     | V    |
| V <sub>VCMPCM</sub>     | VCMP Common Mode voltage range   |   |     | V <sub>DD</sub> |     | V    |
| I <sub>VCMP</sub>       | Active current                   | BIASPROG=0b0000 and HALFBIAS=1 in VCMPn_CTRL register           |     | 0.3             | 0.6 | µA   |
|                         |                                  | BIASPROG=0b1111 and HALFBIAS=0 in VCMPn_CTRL register. LPREF=0. |     | 22              | 35  | µA   |
| t <sub>VCMPREF</sub>    | Startup time reference generator | NORMAL  |     | 10              |     | µs   |
| V <sub>VCMPOFFSET</sub> | Offset voltage                   | Single ended  |     | 10              |     | mV   |
|                         |                                  | Differential  |     | 10              |     | mV   |
| V <sub>VCMPHYST</sub>   | VCMP hysteresis                  |   |     | 61              | 210 | mV   |
| t <sub>VCMPSTART</sub>  | Startup time                     |   |     |                 | 10  | µs   |

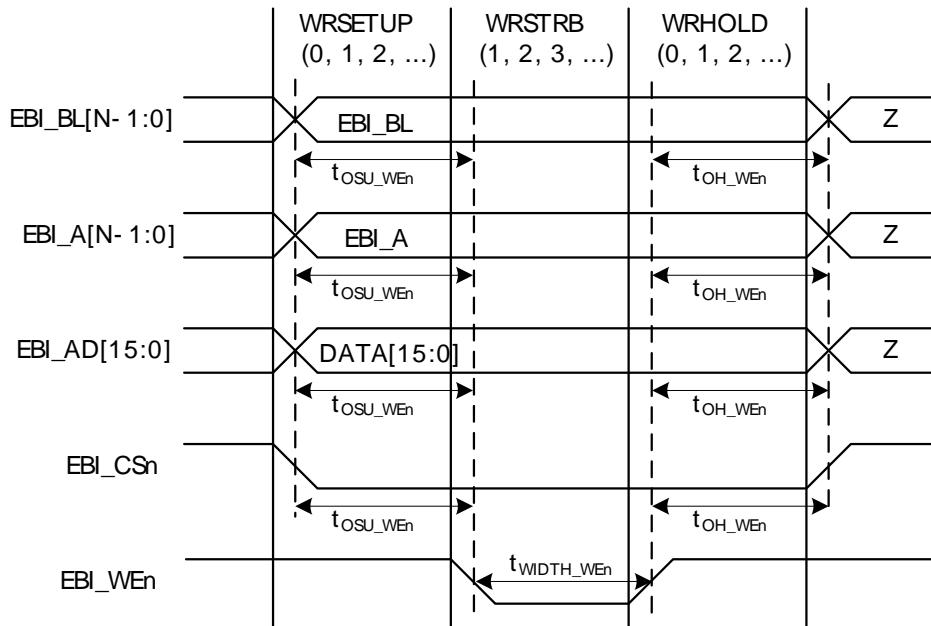
The V<sub>DD</sub> trigger level can be configured by setting the TRIGLEVEL field of the VCMP\_CTRL register in accordance with the following equation:

### VCMP Trigger Level as a Function of Level Setting

$$V_{DD \text{ Trigger Level}} = 1.667V + 0.034 \times \text{TRIGLEVEL} \quad (3.2)$$

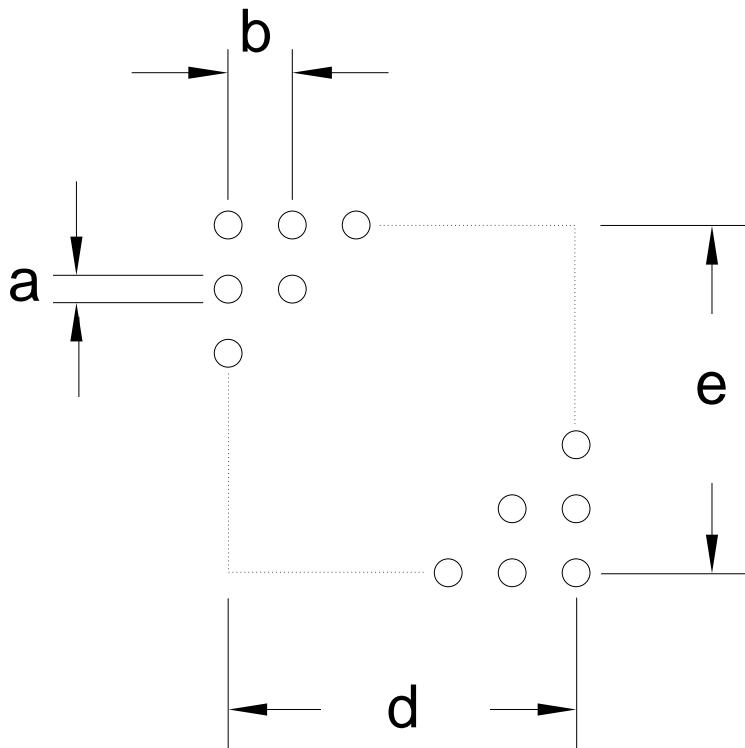
## 3.15 EBI

**Figure 3.38. EBI Write Enable Timing**



| Alternate     | LOCATION |      |      |   |   |   |   |  |
|---------------|----------|------|------|---|---|---|---|--|
| Functionality | 0        | 1    | 2    | 3 | 4 | 5 | 6 | Description  |
| EBI_A22       | PB6      | PB6  | PB6  |   |   |   |   | External Bus Interface (EBI) address output pin 22.                  |
| EBI_A23       | PC0      | PC0  | PC0  |   |   |   |   | External Bus Interface (EBI) address output pin 23.                  |
| EBI_A24       | PC1      | PC1  | PC1  |   |   |   |   | External Bus Interface (EBI) address output pin 24.                  |
| EBI_A25       | PC2      | PC2  | PC2  |   |   |   |   | External Bus Interface (EBI) address output pin 25.                  |
| EBI_A26       | PC4      | PC4  | PC4  |   |   |   |   | External Bus Interface (EBI) address output pin 26.                  |
| EBI_A27       | PD2      | PD2  | PD2  |   |   |   |   | External Bus Interface (EBI) address output pin 27.                  |
| EBI_AD00      | PE8      | PE8  | PE8  |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 00. |
| EBI_AD01      | PE9      | PE9  | PE9  |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 01. |
| EBI_AD02      | PE10     | PE10 | PE10 |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 02. |
| EBI_AD03      | PE11     | PE11 | PE11 |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 03. |
| EBI_AD04      | PE12     | PE12 | PE12 |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 04. |
| EBI_AD05      | PE13     | PE13 | PE13 |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 05. |
| EBI_AD06      | PE14     | PE14 | PE14 |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 06. |
| EBI_AD07      | PE15     | PE15 | PE15 |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 07. |
| EBI_AD08      | PA15     | PA15 | PA15 |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 08. |
| EBI_AD09      | PA0      | PA0  | PA0  |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 09. |
| EBI_AD10      | PA1      | PA1  | PA1  |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 10. |
| EBI_AD11      | PA2      | PA2  | PA2  |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 11. |
| EBI_AD12      | PA3      | PA3  | PA3  |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 12. |
| EBI_AD13      | PA4      | PA4  | PA4  |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 13. |
| EBI_AD14      | PA5      | PA5  | PA5  |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 14. |
| EBI_AD15      | PA6      | PA6  | PA6  |   |   |   |   | External Bus Interface (EBI) address and data input / output pin 15. |
| EBI_ALE       | PF3      | PC11 | PC11 |   |   |   |   | External Bus Interface (EBI) Address Latch Enable output.            |
| EBI_ARDY      | PF2      | PF2  | PF2  |   |   |   |   | External Bus Interface (EBI) Hardware Ready Control input.           |
| EBI_BL0       | PF6      | PF6  | PF6  |   |   |   |   | External Bus Interface (EBI) Byte Lane/Enable pin 0.                 |
| EBI_BL1       | PF7      | PF7  | PF7  |   |   |   |   | External Bus Interface (EBI) Byte Lane/Enable pin 1.                 |
| EBI_CS0       | PD9      | PD9  | PD9  |   |   |   |   | External Bus Interface (EBI) Chip Select output 0.                   |
| EBI_CS1       | PD10     | PD10 | PD10 |   |   |   |   | External Bus Interface (EBI) Chip Select output 1.                   |
| EBI_CS2       | PD11     | PD11 | PD11 |   |   |   |   | External Bus Interface (EBI) Chip Select output 2.                   |
| EBI_CS3       | PD12     | PD12 | PD12 |   |   |   |   | External Bus Interface (EBI) Chip Select output 3.                   |
| EBI_CSTFT     | PA7      | PA7  | PA7  |   |   |   |   | External Bus Interface (EBI) Chip Select output TFT.                 |
| EBI_DCLK      | PA8      | PA8  | PA8  |   |   |   |   | External Bus Interface (EBI) TFT Dot Clock pin.                      |
| EBI_DTEN      | PA9      | PA9  | PA9  |   |   |   |   | External Bus Interface (EBI) TFT Data Enable pin.                    |

| Alternate              | LOCATION |   |   |   |   |   |   |   |
|------------------------|----------|---|---|---|---|---|---|---|
| Functionality          | 0        | 1 | 2 | 3 | 4 | 5 | 6 | Description   |
| LCD SEG3               | PF5      |   |   |   |   |   |   | LCD segment line 3. Segments 0, 1, 2 and 3 are controlled by SEGEN0.  |
| LCD SEG4               | PE8      |   |   |   |   |   |   | LCD segment line 4. Segments 4, 5, 6 and 7 are controlled by SEGEN1.  |
| LCD SEG5               | PE9      |   |   |   |   |   |   | LCD segment line 5. Segments 4, 5, 6 and 7 are controlled by SEGEN1.  |
| LCD SEG6               | PE10     |   |   |   |   |   |   | LCD segment line 6. Segments 4, 5, 6 and 7 are controlled by SEGEN1.  |
| LCD SEG7               | PE11     |   |   |   |   |   |   | LCD segment line 7. Segments 4, 5, 6 and 7 are controlled by SEGEN1.  |
| LCD SEG8               | PE12     |   |   |   |   |   |   | LCD segment line 8. Segments 8, 9, 10 and 11 are controlled by SEGEN2.  |
| LCD SEG9               | PE13     |   |   |   |   |   |   | LCD segment line 9. Segments 8, 9, 10 and 11 are controlled by SEGEN2.  |
| LCD SEG10              | PE14     |   |   |   |   |   |   | LCD segment line 10. Segments 8, 9, 10 and 11 are controlled by SEGEN2.   |
| LCD SEG11              | PE15     |   |   |   |   |   |   | LCD segment line 11. Segments 8, 9, 10 and 11 are controlled by SEGEN2.   |
| LCD SEG12              | PA15     |   |   |   |   |   |   | LCD segment line 12. Segments 12, 13, 14 and 15 are controlled by SEGEN3.   |
| LCD SEG13              | PA0      |   |   |   |   |   |   | LCD segment line 13. Segments 12, 13, 14 and 15 are controlled by SEGEN3.   |
| LCD SEG14              | PA1      |   |   |   |   |   |   | LCD segment line 14. Segments 12, 13, 14 and 15 are controlled by SEGEN3.   |
| LCD SEG15              | PA2      |   |   |   |   |   |   | LCD segment line 15. Segments 12, 13, 14 and 15 are controlled by SEGEN3.   |
| LCD SEG16              | PA3      |   |   |   |   |   |   | LCD segment line 16. Segments 16, 17, 18 and 19 are controlled by SEGEN4.   |
| LCD SEG17              | PA4      |   |   |   |   |   |   | LCD segment line 17. Segments 16, 17, 18 and 19 are controlled by SEGEN4.   |
| LCD SEG18              | PA5      |   |   |   |   |   |   | LCD segment line 18. Segments 16, 17, 18 and 19 are controlled by SEGEN4.   |
| LCD SEG19              | PA6      |   |   |   |   |   |   | LCD segment line 19. Segments 16, 17, 18 and 19 are controlled by SEGEN4.   |
| LCD SEG20/<br>LCD COM4 | PB3      |   |   |   |   |   |   | LCD segment line 20. Segments 20, 21, 22 and 23 are controlled by SEGEN5. This pin may also be used as LCD COM line 4 |
| LCD SEG21/<br>LCD COM5 | PB4      |   |   |   |   |   |   | LCD segment line 21. Segments 20, 21, 22 and 23 are controlled by SEGEN5. This pin may also be used as LCD COM line 5 |
| LCD SEG22/<br>LCD COM6 | PB5      |   |   |   |   |   |   | LCD segment line 22. Segments 20, 21, 22 and 23 are controlled by SEGEN5. This pin may also be used as LCD COM line 6 |
| LCD SEG23/<br>LCD COM7 | PB6      |   |   |   |   |   |   | LCD segment line 23. Segments 20, 21, 22 and 23 are controlled by SEGEN5. This pin may also be used as LCD COM line 7 |
| LCD SEG24              | PF6      |   |   |   |   |   |   | LCD segment line 24. Segments 24, 25, 26 and 27 are controlled by SEGEN6.   |
| LCD SEG25              | PF7      |   |   |   |   |   |   | LCD segment line 25. Segments 24, 25, 26 and 27 are controlled by SEGEN6.   |
| LCD SEG26              | PF8      |   |   |   |   |   |   | LCD segment line 26. Segments 24, 25, 26 and 27 are controlled by SEGEN6.   |
| LCD SEG27              | PF9      |   |   |   |   |   |   | LCD segment line 27. Segments 24, 25, 26 and 27 are controlled by SEGEN6.   |
| LCD SEG28              | PD9      |   |   |   |   |   |   | LCD segment line 28. Segments 28, 29, 30 and 31 are controlled by SEGEN7.   |

**Figure 5.3. BGA120 PCB Stencil Design****Table 5.3. BGA120 PCB Stencil Design Dimensions (Dimensions in mm)**

| Symbol | Dim. (mm) |
|--------|-----------|
| a      | 0.25      |
| b      | 0.50      |
| d      | 6.00      |
| e      | 6.00      |

1. The drawings are not to scale.
2. All dimensions are in millimeters.
3. All drawings are subject to change without notice.
4. The PCB Land Pattern drawing is in compliance with IPC-7351B.
5. Stencil thickness 0.125 mm.
6. For detailed pin-positioning, see Figure 4.3 (p. 71) .

## 5.2 Soldering Information

The latest IPC/JEDEC J-STD-020 recommendations for Pb-Free reflow soldering should be followed.

The packages have a Moisture Sensitivity Level rating of 3, please see the latest IPC/JEDEC J-STD-033 standard for MSL description and level 3 bake conditions.

## 7 Revision History

### 7.1 Revision 1.40

June 13th, 2014

Removed "Preliminary" markings.

Corrected single power supply voltage minimum value from 1.85V to 1.98V.

Added AUXHFRCO to blockdiagram and electrical characteristics.

Updated current consumption data.

Updated transition between energy modes data.

Updated power management data.

Updated GPIO data.

Updated LFRCO, HFRCO and ULFRCO data.

Updated ADC data.

Updated DAC data.

Updated OPAMP data.

Updated ACMP data.

Updated VCMP data.

Added EBI timing chapter.

### 7.2 Revision 1.31

November 21st, 2013

Updated figures.

Updated errata-link.

Updated chip marking.

Added link to Environmental and Quality information.

Re-added missing DAC-data.

### 7.3 Revision 1.30

September 30th, 2013

Added I2C characterization data.

Added SPI characterization data.

Corrected the DAC and OPAMP2 pin sharing information in the Alternate Functionality Pinout section.

Corrected the ADC resolution from 12, 10 and 6 bit to 12, 8 and 6 bit.

## List of Tables

|  |    |
|--|----|
| 1.1. Ordering Information .....                                    | 2  |
| 2.1. Configuration Summary .....                                   | 7  |
| 3.1. Absolute Maximum Ratings .....                                | 10 |
| 3.2. General Operating Conditions .....                            | 10 |
| 3.3. Environmental .....   | 11 |
| 3.4. Current Consumption .....                                     | 11 |
| 3.5. Energy Modes Transitions .....                                | 17 |
| 3.6. Power Management .....  | 18 |
| 3.7. Flash .....   | 18 |
| 3.8. GPIO .....  | 19 |
| 3.9. LFXO .....  | 27 |
| 3.10. HFXO .....   | 27 |
| 3.11. LFRCO .....  | 28 |
| 3.12. HFRCO .....  | 29 |
| 3.13. AUXHFRCO .....   | 32 |
| 3.14. ULFRCO .....   | 32 |
| 3.15. ADC .....  | 32 |
| 3.16. DAC .....  | 42 |
| 3.17. OPAMP .....  | 43 |
| 3.18. ACMP .....   | 47 |
| 3.19. VCMP .....   | 49 |
| 3.20. EBI Write Enable Timing .....                                | 50 |
| 3.21. EBI Address Latch Enable Related Output Timing .....         | 50 |
| 3.22. EBI Read Enable Related Output Timing .....                  | 51 |
| 3.23. EBI Read Enable Related Timing Requirements .....            | 52 |
| 3.24. EBI Ready/Wait Related Timing Requirements .....             | 52 |
| 3.25. LCD .....  | 53 |
| 3.26. I2C Standard-mode (Sm) .....                                 | 54 |
| 3.27. I2C Fast-mode (Fm) .....                                     | 54 |
| 3.28. I2C Fast-mode Plus (Fm+) .....                               | 55 |
| 3.29. SPI Master Timing .....                                      | 55 |
| 3.30. SPI Master Timing with SSSEARLY and SMSDELAY .....           | 56 |
| 3.31. SPI Slave Timing .....                                       | 56 |
| 3.32. SPI Slave Timing with SSSEARLY and SMSDELAY .....            | 56 |
| 3.33. Digital Peripherals .....                                    | 57 |
| 4.1. Device Pinout .....   | 58 |
| 4.2. Alternate functionality overview .....                        | 63 |
| 4.3. GPIO Pinout .....   | 70 |
| 5.1. BGA120 PCB Land Pattern Dimensions (Dimensions in mm) .....   | 73 |
| 5.2. BGA120 PCB Solder Mask Dimensions (Dimensions in mm) .....    | 74 |
| 5.3. BGA120 PCB Stencil Design Dimensions (Dimensions in mm) ..... | 75 |

## List of Equations

|   |    |
|---|----|
| 3.1. Total ACMP Active Current .....                                      | 47 |
| 3.2. VCMP Trigger Level as a Function of Level Setting .....              | 49 |
| 3.3. Total LCD Current Based on Operational Mode and Internal Boost ..... | 53 |